

PROGRAMMABLE TIMING CONTROL HUB FOR INTEL BASED SYSTEMS
ICS9LRS3187B
Recommended Application:

CK505 version 1.1 clock, with fully integrated voltage regulators and series resistors

Output Features:

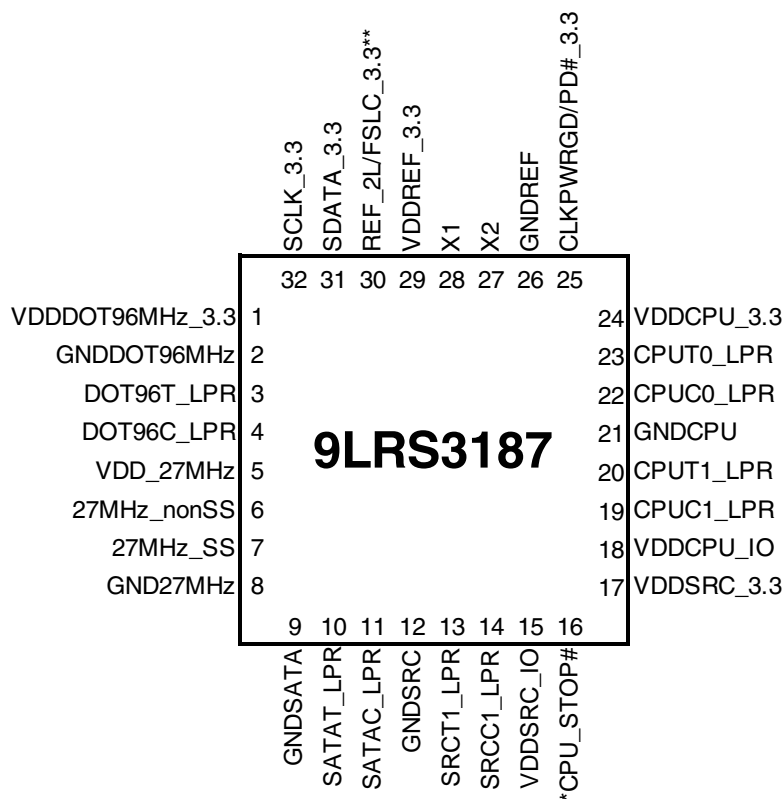
- 2 - CPU differential low power push-pull pairs
- 1 - SRC differential low power push-pull pair
- 1 - SATA differential low power push-pull pair
- 1 - DOT differential low power push-pull pair
- 1 - REF, able to drive 3 loads, 14.318MHz
- 1 - 27MHz_SS/non_SS single-ended output pair

Features/Benefits:

- Supports spread spectrum modulation, 0 to -0.5% down spread for CPU and SRC clocks
- Uses external 14.318MHz crystal, external crystal load caps are required for frequency tuning
- Available in commercial (0 to +70°C) and industrial (-40 to +85°C) temperature ranges
- Meets PCIe Gen2 specifications

Key Specifications:

- CPU outputs cycle-cycle jitter <85ps
- SRC outputs cycle-cycle jitter <125ps
- +/- 100ppm frequency accuracy on all clocks

Pin Configuration


** Internal Pull-Down Resistor

* Internal Pull-Up Resistor

32-pin MLF

Pin Description

| Pin# | Pin Name | Type | Pin Description |
|------|------------------|------|--|
| 1 | VDDDOT96MHz_3.3 | PWR | Power pin for the 96MHz output 3.3V. |
| 2 | GNDDOT96MHz | PWR | Ground pin for the 96MHz output |
| 3 | DOT96T_LPR | OUT | True DOT96 output with integrated 33ohm series resistor. No 50ohm resistor to GND needed. |
| 4 | DOT96C_LPR | OUT | Complement DOT96 output with integrated 33ohm series resistor. No 50ohm resistor to GND needed. |
| 5 | VDD_27MHz | PWR | Power pin for the 27MHz output 3.3V. |
| 6 | 27MHz_nonSS | OUT | 3.3V Single-ended 27MHz non-spread clock. |
| 7 | 27MHz_SS | OUT | 3.3V Single-ended 27MHz spread clock. |
| 8 | GND27MHz | OUT | Ground pin for the 27MHz outputs. |
| 9 | GNDSATA | PWR | Ground pin for the SATA outputs. |
| 10 | SATAT_LPR | OUT | True clock of differential 0.8V push-pull SATA/SRC output with integrated 33ohm series resistor. No 50ohm resistor to GND needed. |
| 11 | SATAC_LPR | OUT | Complementary clock of differential 0.8V push-pull SATA/SRC output with integrated 33ohm series resistor. No 50ohm resistor to GND needed. |
| 12 | GNDSRC | PWR | Ground pin for the SRC outputs |
| 13 | SRCT1_LPR | OUT | True clock of differential 0.8V push-pull SRC output with integrated 33ohm series resistor. No 50ohm resistor to GND needed. |
| 14 | SRCC1_LPR | OUT | Complementary clock of differential 0.8V push-pull SRC output with integrated 33ohm series resistor. No 50ohm resistor to GND needed. |
| 15 | VDDSRC_IO | PWR | 1.05V to 3.3V from external power supply |
| 16 | *CPU_STOP# | IN | Stops all CPU clocks, except those set to be free running clocks |
| 17 | VDDSRC_3.3 | PWR | Supply for SRC clocks, 3.3V nominal |
| 18 | VDDCPU_IO | PWR | 1.05V to 3.3V from external power supply |
| 19 | CPUC1_LPR | OUT | Complementary clock of differential pair 0.8V push-pull CPU outputs with integrated 33ohm series resistor. No 50 ohm resistor to GND needed. |
| 20 | CPUT1_LPR | OUT | True clock of differential pair 0.8V push-pull CPU outputs with integrated 33ohm series resistor. No 50 ohm resistor to GND needed. |
| 21 | GNDCPU | PWR | Ground pin for the CPU outputs. |
| 22 | CPUC0_LPR | OUT | Complementary clock of differential pair 0.8V push-pull CPU outputs with integrated 33ohm series resistor. No 50 ohm resistor to GND needed. |
| 23 | CPUT0_LPR | OUT | True clock of differential pair 0.8V push-pull CPU outputs with integrated 33ohm series resistor. No 50 ohm resistor to GND needed. |
| 24 | VDDCPU_3.3 | PWR | Supply for CPU clocks, 3.3V nominal |
| 25 | CLKPWRGD/PD#_3.3 | IN | Notifies CK505 to sample latched inputs, or PWRDWN# mode |
| 26 | GNDREF | PWR | Ground pin for the REF outputs. |
| 27 | X2 | OUT | Crystal output, Nominally 14.318MHz |
| 28 | X1 | IN | Crystal input, Nominally 14.318MHz |
| 29 | VDDREF_3.3 | PWR | Power pin for the XTAL and REF clocks, nominal 3.3V |
| 30 | REF_2/FSLC_3.3** | I/O | 14.318 MHz reference clock, which can drive 2 loads / 3.3V tolerant input for CPU frequency selection. Refer to input electrical characteristics for V_{il_FS} and V_{ih_FS} values. |
| 31 | SDATA_3.3 | I/O | Data pin for SMBus circuitry, 3.3V tolerant |
| 32 | SCLK_3.3 | IN | Clock pin of SMBus circuitry, 3.3V tolerant. |

General Description

The **ICS9LRS3187B** is a CK505 clock synthesizer. The **ICS9LRS3187B** provides a single-chip solution for Intel based systems. The **ICS9LRS3187B** is driven with a 14.318MHz crystal.

Functional Block Diagram

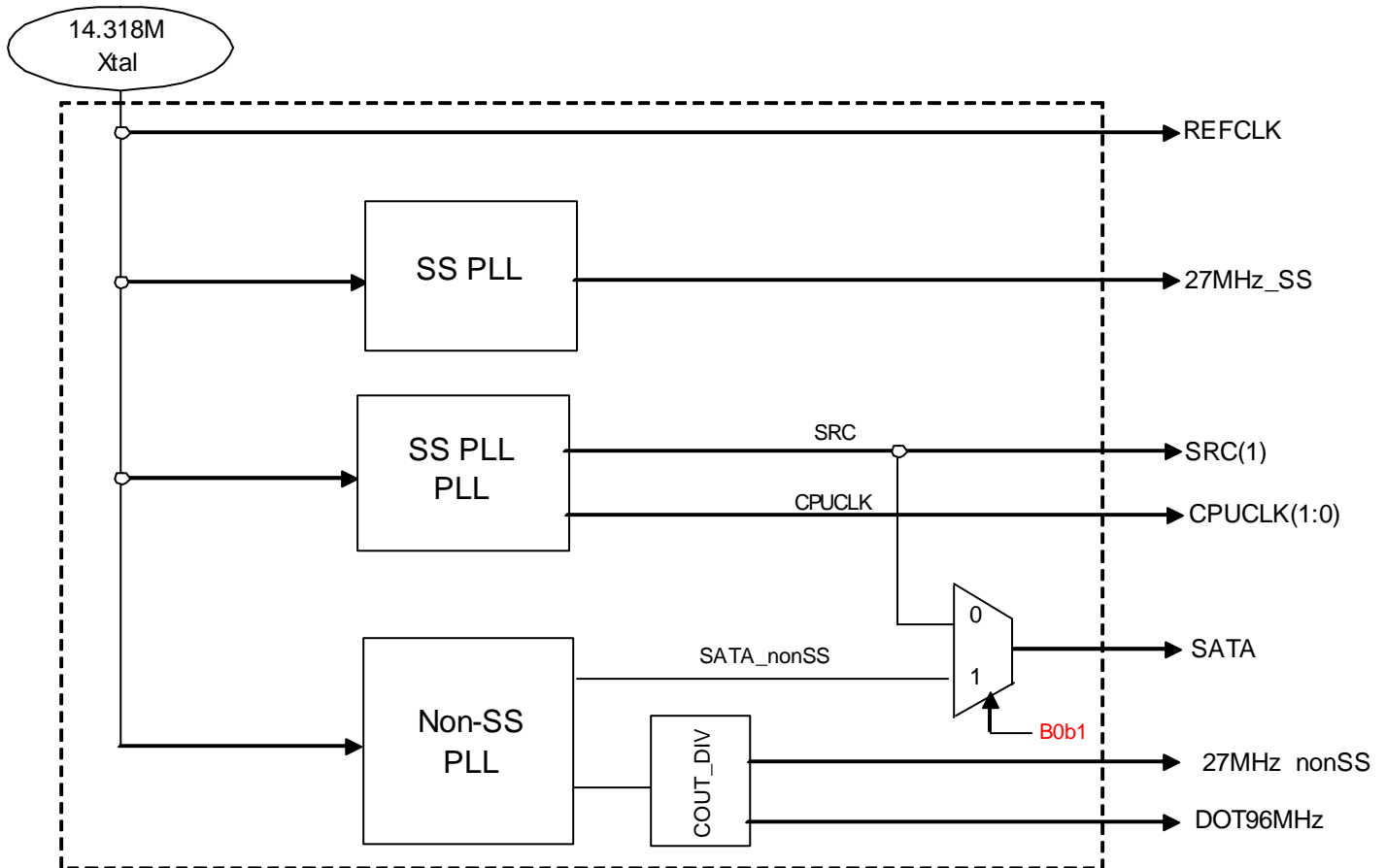


Table: Power Distribution

| Ground | VDD_IO | VDD 3.3V | Output |
|--------|--------|----------|--------|
| 2 | | 1 | DOT96 |
| 8 | | 5 | 27M |
| 9 | 15 | 17 | SATA |
| 12 | 15 | 17 | SRC |
| 21 | 18 | 24 | CPU |
| 26 | | 29 | REF |

Table 1: CPU Frequency Select Table

| FS _L C B0b7 | CPU MHz | SRC MHz | REF MHz | DOT MHz |
|---------------------------|------------|------------|------------|------------|
| 0 (Default) | 133.33 | 100.00 | 14.318 | 96.00 |
| 1 | 100.00 | | | |

1. FS_LC is a low-threshold input. Please see V_{IL,FS} and V_{IH,FS} specifications in the Input/Supply/Common Output Parameters Table for correct values. Also refer to the Test Clarification Table.

Table 2: pin 6, 7 Configuration

| B1b3 | B1b2 | B1b1 | Pin 6 | Pin 7 | Spread | Comment |
|----------|----------|----------|--------------------|-----------------|--------------|----------------|
| | | | MHz | MHz | % | |
| 0 | 0 | 0 | 27MHz_nonSS | 27MHz_SS | -1.75% | |
| 0 | 0 | 1 | 27MHz_nonSS | 27MHz_SS | +0.5% | |
| 0 | 1 | 0 | 27MHz_nonSS | 27MHz_SS | -0.5% | Default |
| 0 | 1 | 1 | 27MHz_nonSS | 27MHz_SS | -1% | |
| 1 | 0 | 0 | 27MHz_nonSS | 27MHz_SS | -1.5% | |
| 1 | 0 | 1 | 27MHz_nonSS | 27MHz_SS | -2% | |
| 1 | 1 | 0 | 27MHz_nonSS | 27MHz_SS | -0.75% | |
| 1 | 1 | 1 | 27MHz_nonSS | 27MHz_SS | -1.25% | |

Table 3: IO_Vout select table

| B9b2 | B9b1 | B9b0 | IO_Vout |
|------|------|------|---------|
| 0 | 0 | 0 | 0.3V |
| 0 | 0 | 1 | 0.4V |
| 0 | 1 | 0 | 0.5V |
| 0 | 1 | 1 | 0.6V |
| 1 | 0 | 0 | 0.7V |
| 1 | 0 | 1 | 0.8V |
| 1 | 1 | 0 | 0.9V |
| 1 | 1 | 1 | 1.0V |

CPU Power Management Table

| PD# | CPU_STOP# | SMBus Reg. OE | CPU1 | CPU1# | CPU0 | CPU0# |
|-----------|-----------|------------------|---------|---------|---------|---------|
| 1 | 1 | Enable | Running | Running | Running | Running |
| 0 | X | Enable | Low/20K | Low | Low/20K | Low |
| 1 | 0 | Enable | High | Low | High | Low |
| 1 | X | Disable | Low/20K | Low | Low/20K | Low |
| M1 | | | Running | Running | Low/20K | Low |

SRC and DOT96MHz Power Management Table

| PD# | CPU_STOP# | SMBus Reg. OE | SRC | SRC# | DOT | DOT# |
|-----------|-----------|------------------|---------|---------|---------|---------|
| 0 | X | Enable | Low/20K | Low | Low/20K | Low |
| 1 | X | Enable | Running | Running | Running | Running |
| 1 | X | Disable | Low/20K | Low | Low/20K | Low |
| M1 | | | Low/20K | Low | Low/20K | Low |

Singled-ended Power Management Table

| PD# | CPU_STOP# | SMBus Reg. OE | 27M | REF |
|-----------|-----------|------------------|---------|---------|
| 1 | X | Enable | Running | Running |
| 0 | X | Enable | Low | Hi-Z |
| 1 | X | Disable | Low | Low |
| M1 | | | Low | Hi-Z |

General SMBus serial interface information for the ICS9LRS3187B

How to Write:

- Controller (host) sends a start bit.
- Controller (host) sends the write address $D2_{(H)}$
- IDT clock will **acknowledge**
- Controller (host) sends the beginning byte location = N
- IDT clock will **acknowledge**
- Controller (host) sends the data byte count = X
- IDT clock will **acknowledge**
- Controller (host) starts sending **Byte N through Byte N + X - 1**
- IDT clock will **acknowledge** each byte **one at a time**
- Controller (host) sends a Stop bit

How to Read:

- Controller (host) will send start bit.
- Controller (host) sends the write address $D2_{(H)}$
- IDT clock will **acknowledge**
- Controller (host) sends the beginning byte location = N
- IDT clock will **acknowledge**
- Controller (host) will send a separate start bit.
- Controller (host) sends the read address $D3_{(H)}$
- IDT clock will **acknowledge**
- IDT clock will send the data byte count = X
- IDT clock sends **Byte N + X - 1**
- IDT clock sends **Byte 0 through byte X (if $X_{(H)}$ was written to byte 8).**
- Controller (host) will need to acknowledge each byte
- Controller (host) will send a not acknowledge bit
- Controller (host) will send a stop bit

| Index Block Write Operation | | |
|-----------------------------|-----------|----------------------|
| Controller (Host) | | IDT (Slave/Receiver) |
| T | starT bit | |
| Slave Address $D2_{(H)}$ | | |
| WR | WRite | |
| | | ACK |
| Beginning Byte = N | | |
| | | ACK |
| Data Byte Count = X | | |
| | | ACK |
| Beginning Byte N | X Byte | |
| ◊ | | ACK |
| ◊ | | ◊ |
| ◊ | | ◊ |
| ◊ | | ◊ |
| Byte N + X - 1 | | |
| | | ACK |
| P | stoP bit | |

| Index Block Read Operation | | |
|----------------------------|-----------------|----------------------|
| Controller (Host) | | IDT (Slave/Receiver) |
| T | starT bit | |
| Slave Address $D2_{(H)}$ | | |
| WR | WRite | |
| | | ACK |
| Beginning Byte = N | | |
| | | ACK |
| RT | Repeat starT | |
| Slave Address $D3_{(H)}$ | | |
| RD | ReaD | |
| | | ACK |
| | | Data Byte Count = X |
| ACK | | |
| | | Beginning Byte N |
| ACK | | |
| ◊ | | ◊ |
| ◊ | | ◊ |
| ◊ | | ◊ |
| | | Byte N + X - 1 |
| N | Not acknowledge | |
| P | stoP bit | |

Byte 0 FS Readback and PLL Selection Register

| Bit | Pin | Name | Description | Type | 0 | 1 | Default |
|-----|-----|------------|--|--------------------|--|---------------------------------------|---------|
| 7 | - | FSLC | CPU Freq. Sel. Bit | R | | | Latch |
| 6 | - | Reserved | Reserved | RW | - | - | 0 |
| 5 | - | Reserved | Reserved | RW | - | - | 1 |
| 4 | - | iAMT_EN | Set via SMBus | RW (Sticky "1") | Legacy Mode | iAMT Enabled | 0 |
| 3 | | Reserved | Reserved | RW | | | 0 |
| 2 | - | Reserved | Reserved | RW | | | 0 |
| 1 | - | SATA_SEL | Select source for SATA clock | RW | SATA (SRC2 100MHz_SS) = SRC_Main | SATA (100MHz non_SS) = SATA PLL | 0 |
| 0 | - | PD_Restore | 1 = on Power Down de-assert return to last known state 0 = clear all SMBus configurations as if cold power-on and go to latches open state This bit is ignored and treated at '1' if device is in iAMT mode. | RW | Configuration Not Saved | Configuration Saved | 1 |

Byte 1 DOT96 Select and PLL3 Quick Config Register,

| Bit | Pin | Name | Description | Type | 0 | 1 | Default |
|-----|-----|-----------------|--------------------------------|------|------------------------------------|---------------|---------|
| 7 | | Reserved | Reserved | RW | - | - | 1 |
| 6 | | SRC_PLL_SSC_SEL | Select 0.5% down or center SSC | RW | Down spread | Center spread | 0 |
| 5 | | Reserved | Reserved | RW | - | - | 1 |
| 4 | | Reserved | Reserved | RW | | | 0 |
| 3 | | 27SS PLL CF2 | 27SS PLL Quick Config Bit 2 | RW | See Table 2: pin 6/7 Configuration | | 0 |
| 2 | | 27SS PLL_CF1 | 27SS PLL Quick Config Bit 1 | RW | | 1 | |
| 1 | | 27SS PLL CF0 | 27SS PLL Quick Config Bit 0 | RW | | 0 | |
| 0 | | Reserved | Reserved | RW | - | - | 1 |

Byte 2 Output Enable Register

| Bit | Pin | Name | Description | Type | 0 | 1 | Default |
|-----|-----|-----------|--|------|-----------------|----------------|---------|
| 7 | | REF_3L_OE | Output enable for REF0, if disabled output is tri-stated | RW | Output Disabled | Output Enabled | 1 |
| 6 | | Reserved | Reserved | RW | - | - | 1 |
| 5 | | Reserved | Reserved | RW | - | - | 1 |
| 4 | | Reserved | Reserved | RW | - | - | 1 |
| 3 | | Reserved | Reserved | RW | - | - | 1 |
| 2 | | Reserved | Reserved | RW | - | - | 1 |
| 1 | | Reserved | Reserved | RW | - | - | 1 |
| 0 | | Reserved | Reserved | RW | - | - | 1 |

Byte 3 Output Enable Register

| Bit | Pin | Name | Description | Type | 0 | 1 | Default |
|-----|-----|----------|-------------|------|---|---|---------|
| 7 | | Reserved | Reserved | RW | - | - | 1 |
| 6 | | Reserved | Reserved | RW | - | - | 1 |
| 5 | | Reserved | Reserved | RW | - | - | 1 |
| 4 | | Reserved | Reserved | RW | - | - | 1 |
| 3 | | Reserved | Reserved | RW | - | - | 1 |
| 2 | | Reserved | Reserved | RW | - | - | 1 |
| 1 | | Reserved | Reserved | RW | - | - | 1 |
| 0 | | Reserved | Reserved | RW | - | - | 1 |

Byte 4 Output Enable and Spread Spectrum Disable Register

| Bit | Pin | Name | Description | Type | 0 | 1 | Default |
|-----|-----|------------|---------------------------------|------|-----------------|----------------|---------|
| 7 | | Reserved | Reserved | RW | - | - | 1 |
| 6 | | SATA_OE | Output enable for SATA | RW | Output Disabled | Output Enabled | 1 |
| 5 | | SRC1_OE | Output enable for SRC1 | RW | Output Disabled | Output Enabled | 1 |
| 4 | | DOT96_OE | Output enable for DOT96 | RW | Output Disabled | Output Enabled | 1 |
| 3 | | CPU1_OE | Output enable for CPU1 | RW | Output Disabled | Output Enabled | 1 |
| 2 | | CPU0_OE | Output enable for CPU0 | RW | Output Disabled | Output Enabled | 1 |
| 1 | | 27SS_ON | Enable 27SS's spread modulation | RW | Spread Disabled | Spread Enabled | 1 |
| 0 | | SRC_SSC_ON | Enable SRC's spread modulation | RW | Spread Disabled | Spread Enabled | 1 |

Byte 5 Reserved Register

| Bit | Pin | Name | Description | Type | 0 | 1 | Default |
|-----|-----|----------|-------------|------|---|---|---------|
| 7 | | Reserved | Reserved | RW | - | - | 1 |
| 6 | | Reserved | Reserved | RW | - | - | 1 |
| 5 | | Reserved | Reserved | RW | - | - | 1 |
| 4 | | Reserved | Reserved | RW | - | - | 1 |
| 3 | | Reserved | Reserved | RW | - | - | 1 |
| 2 | | Reserved | Reserved | RW | - | - | 1 |
| 1 | | Reserved | Reserved | RW | - | - | 1 |
| 0 | | Reserved | Reserved | RW | - | - | 1 |

Byte 6 Slew Rate Control Register

| Bit | Pin | Name | Description | Type | 0 | 1 | Default |
|-----|-----|------------|-------------------|------|--------|--------|---------|
| 7 | | Reserved | Reserved | RW | - | - | 0 |
| 6 | | Reserved | Reserved | RW | - | - | 0 |
| 5 | | REF Slew | Slew Rate Control | RW | 2 V/ns | 1 V/ns | 0 |
| 4 | | Reserved | Reserved | RW | - | - | 0 |
| 3 | | 27MHz Slew | Slew Rate Control | RW | 2 V/ns | 1 V/ns | 0 |
| 2 | | Reserved | Reserved | RW | - | - | 0 |
| 1 | | Reserved | Reserved | RW | - | - | 0 |
| 0 | | Reserved | Reserved | RW | - | - | 0 |

Byte 7 Vendor ID/ Revision ID

| Bit | Pin | Name | Description | Type | 0 | 1 | Default |
|-----|-----|-----------------|----------------------------------|------|-----------------|---|---------|
| 7 | | Rev Code Bit 3 | Revision ID | R | Vendor specific | | X |
| 6 | | Rev Code Bit 2 | | R | | | X |
| 5 | | Rev Code Bit 1 | | R | | | X |
| 4 | | Rev Code Bit 0 | | R | | | X |
| 3 | | Vendor ID bit 3 | Vendor ID ICS is 0001, binary | R | | | 0 |
| 2 | | Vendor ID bit 2 | | R | | | 0 |
| 1 | | Vendor ID bit 1 | | R | | | 0 |
| 0 | | Vendor ID bit 0 | | R | 1 | | |

Byte 8 Device ID and Output Enable Register

| Bit | Pin | Name | Description | Type | 0 | 1 | Default |
|-----|-----|----------------|--|------|---------------------|---------|---------|
| 7 | | Device_ID3 | Table of Device identifier codes, used for differentiating between CK505 package options, etc. | R | See Device ID Table | | 1 |
| 6 | | Device_ID2 | | R | | | 0 |
| 5 | | Device_ID1 | | R | | | 0 |
| 4 | | Device_ID0 | | R | | | 0 |
| 3 | | Reserved | Reserved | RW | - | - | 0 |
| 2 | | Reserved | Reserved | RW | - | - | 0 |
| 1 | | 27MHz_nonSS_OE | Output enable for 27MHz_nonSS | RW | Disabled | Enabled | 1 |
| 0 | | 27MHz_SS_OE | Output enable for 27MHz_SS | RW | Disabled | Enabled | 1 |

Byte 9 Output Control Register

| Bit | Pin | Name | Description | Type | 0 | 1 | Default |
|-----|-----|----------|--|------|--|---|---------|
| 7 | | Reserved | Reserved | RW | - | - | 0 |
| 6 | | Reserved | Reserved | R | - | - | 0 |
| 5 | | Reserved | Reserved | RW | - | - | 1 |
| 4 | | Reserved | Reserved | RW | - | - | 0 |
| 3 | | Reserved | Reserved | RW | - | - | 0 |
| 2 | | IO_VOUT2 | IO Output Voltage Select (Most Significant Bit) | RW | See Table 3: V_IO Selection (Default is 0.8V) | | 1 |
| 1 | | IO_VOUT1 | IO Output Voltage Select | RW | | | 0 |
| 0 | | IO_VOUT0 | IO Output Voltage Select (Least Significant Bit) | RW | | | 1 |

Byte 10 Output Control Register

| Bit | Pin | Name | Description | Type | 0 | 1 | Default |
|-----|-----|-------------------|---|------|--------------|-----------|---------|
| 7 | | Reserved | Reserved | RW | - | - | 0 |
| 6 | | Reserved | Reserved | RW | - | - | 0 |
| 5 | | Reserved | Reserved | RW | - | - | 0 |
| 4 | | Reserved | Reserved | RW | - | - | 0 |
| 3 | | Reserved | Reserved | RW | - | - | 0 |
| 2 | | Reserved | Reserved | RW | - | - | 0 |
| 1 | | CPU 1 Stop Enable | Enables control of CPU1 with CPU_STOP# | RW | Free Running | Stoppable | 1 |
| 0 | | CPU 0 Stop Enable | Enables control of CPU 0 with CPU_STOP# | RW | Free Running | Stoppable | 1 |

Byte 11 Reserved Register

| Bit | Pin | Name | Description | Type | 0 | 1 | Default |
|-----|-----|-------------|------------------------------------|------|----------|-------------------------|---------|
| 7 | | Reserved | Reserved | RW | | | 0 |
| 6 | | Reserved | Reserved | RW | | | 0 |
| 5 | | Reserved | Reserved | RW | | | 0 |
| 4 | | Reserved | Reserved | RW | | | 0 |
| 3 | | Reserved | Reserved | RW | - | - | 0 |
| 2 | | CPU1_AMT_EN | M1 mode clk enable | RW | Disable | Enable | 1 |
| 1 | | PCI-E_GEN2 | Determines if PCI-E Gen2 compliant | R | non-Gen2 | PCI-E Gen2 Compliant | 1 |
| 0 | | Reserved | Reserved | RW | - | - | 1 |

Byte 12 Byte Count Register

| Bit | Pin | Name | Description | Type | 0 | 1 | Default |
|-----|-----|----------|--|------|---|---|---------|
| 7 | | Reserved | | RW | | | 0 |
| 6 | | Reserved | | RW | | | 0 |
| 5 | | BC5 | Read Back byte count register, max bytes = 32 | RW | | | 0 |
| 4 | | BC4 | | RW | | | 0 |
| 3 | | BC3 | | RW | | | 1 |
| 2 | | BC2 | | RW | | | 1 |
| 1 | | BC1 | | RW | | | 0 |
| 0 | | BC0 | | RW | | | 1 |

Absolute Maximum Ratings - DC Parameters, Commercial Temperature Range

| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | UNITS | Notes |
|------------------------|-----------------|-------------------------------------|-----------|-----|-----|-------|-------|
| Maximum Supply Voltage | VDDxxx | Supply Voltage | | | 4.6 | V | 1 |
| Maximum Supply Voltage | VDDxxx_IO | Low-Voltage Differential I/O Supply | | | 3.8 | V | 1 |
| Maximum Input Voltage | V _{IH} | 3.3V Inputs | | | 4.6 | V | 1,2 |
| Minimum Input Voltage | V _{IL} | Any Input | GND - 0.5 | | | V | 1 |
| Storage Temperature | T _s | - | -65 | | 150 | °C | 1 |
| Input ESD protection | ESD prot | Human Body Model | 2000 | | | V | 1,3 |

Notes: (unless otherwise noted, guaranteed by design and characterization, not 100% tested in production).

¹ Operation under these conditions is neither implied, nor guaranteed.

² Maximum V_{IH} is not to exceed VDD

³ Human Body Model

Electrical Characteristics - Input/Supply/Common Output DC Parameters, Commercial Temperature Range

| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | UNITS | Notes |
|---|------------------------|---|-----------------------|---------|-----------------------|-------|-------|
| Ambient Operating Temp | T _{ambient} | - | 0 | | 70 | °C | |
| Supply Voltage | VDDxxx | Supply Voltage | 3.135 | | 3.465 | V | |
| Supply Voltage | VDDxxx_IO | Low-Voltage Differential I/O Supply | 0.9975 | | 3.465 | V | 5 |
| Input High Voltage | V _{IHSE} | Single-ended 3.3V inputs | 2 | | V _{DD} + 0.3 | V | 3 |
| Input Low Voltage | V _{ILSE} | Single-ended 3.3V inputs | V _{SS} - 0.3 | | 0.8 | V | 3 |
| Low Threshold Input- FSC = '1' Voltage | V _{IH_FSC} | 3.3 V +/-5% | 0.7 | | 3.3 | V | 4 |
| Low Threshold Input-Low Voltage | V _{IL_FSC} | 3.3 V +/-5% | V _{SS} - 0.3 | | 0.35 | V | |
| Input Leakage Current | I _{IN} | V _{IN} = V _{DD} , V _{IN} = GND | -5 | | 5 | uA | 2 |
| Input Leakage Current | I _{INRES} | Inputs with pull up or pull down resistors V _{IN} = V _{DD} , V _{IN} = GND | -200 | | 200 | uA | |
| Output High Voltage | V _{OHSE} | Single-ended outputs, I _{OH} = -1mA | 2.4 | | | V | 1 |
| Output Low Voltage | V _{OLSE} | Single-ended outputs, I _{OL} = 1 mA | | | 0.4 | V | 1 |
| Operating Supply Current | I _{DDOP3.3} | Full Active, C _L = Full load; I _{DD} 3.3V | | 85 | 110 | mA | |
| | I _{DDOPIO} | Full Active, C _L = Full load; I _{DD} IO | | 18 | 25 | mA | 5 |
| iAMT Mode Current | I _{DDIAMT3.3} | M1 mode, 3.3V Rail | | 48 | 60 | mA | |
| | I _{DDIAMTIO} | M1 Mode, IO Rail | | 6 | 10 | mA | 5 |
| Powerdown Current | I _{DDPD3.3} | Power down mode, 3.3V Rail | | 6 | 5 | mA | |
| | I _{DDPDIO} | Power down mode, IO Rail | | 0 | 0.1 | mA | 5 |
| Input Frequency | F _i | V _{DD} = 3.3 V | | 14.3182 | 15 | MHz | |
| Pin Inductance | L _{pin} | | | | 7 | nH | |
| Input Capacitance | C _{IN} | Logic Inputs | 1.5 | | 5 | pF | |
| | C _{OUT} | Output pin capacitance | | | 6 | pF | |
| | C _{INX} | X1 & X2 pins | | | 6 | pF | |
| Clk Stabilization | T _{STAB} | From VDD Power-Up or de-assertion of PD to 1st clock | | 1.0 | 1.8 | ms | |
| T _{fall_SE} | T _{FALL} | Fall/rise time of all 3.3V control inputs from 20-80% | | | 10 | ns | 1 |
| T _{rise_SE} | T _{RISE} | | | | 10 | ns | 1 |
| SMBus Voltage | V _{DD} | | 2.7 | | 5.5 | V | |
| Low-level Output Voltage | V _{OLSMB} | @ I _{PULLUP} | | | 0.4 | V | |
| Current sinking at V _{OLSMB} = 0.4 V | I _{PULLUP} | SMB Data Pin | 4 | 5 | | mA | |
| SCLK/SDATA Clock/Data Rise Time | T _{RI2C} | (Max V _{IL} - 0.15) to (Min V _{IH} + 0.15) | | | 1000 | ns | |
| SCLK/SDATA Clock/Data Fall Time | T _{FI2C} | (Min V _{IH} + 0.15) to (Max V _{IL} - 0.15) | | | 300 | ns | |
| Maximum SMBus Operating Frequency | F _{SMBUS} | | | | 100 | kHz | |
| Spread Spectrum Modulation Frequency | f _{SSMOD} | Triangular Modulation | 30 | 32.54 | 33 | kHz | |

Notes: (unless otherwise noted, guaranteed by design and characterization, not 100% tested in production).

¹Signal is required to be monotonic in this region.

² Input leakage current does not include inputs with pull-up or pull-down resistors

³ 3.3V referenced inputs are: SCLK, SDATA, and CKPWRGD

⁴ Frequency Select pins which have tri-level input

⁵ If present, not all parts have this feature.

AC Electrical Characteristics - Low Power Differential Outputs, Commercial Temperature Range

| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | UNITS | Notes |
|----------------------------|-----------------------|--|------|------|------|-------|-------|
| Rising Edge Slew Rate | tSLR | Averaging on | 2.5 | 3.7 | 4 | V/ns | 2, 3 |
| Falling Edge Slew Rate | tFLR | Averaging on | 2.5 | 3.7 | 4 | V/ns | 2, 3 |
| Slew Rate Variation | tSLVAR | Averaging on | | 3.6 | 20 | % | 1, 6 |
| Differential Voltage Swing | VSWING | Averaging off | 300 | | | mV | 2 |
| Crossing Point Voltage | VXABS | Averaging off | 300 | 446 | 550 | mV | 1,4,5 |
| Crossing Point Variation | VXABSVAR | Averaging off | | 70 | 140 | mV | 1,4,9 |
| Maximum Output Voltage | VHIGH | Averaging off | | | 1150 | mV | 1,7 |
| Minimum Output Voltage | VLOW | Averaging off | -300 | | | mV | 1,8 |
| Duty Cycle | DCYC | Averaging on | 45 | 49.8 | 55 | % | 2 |
| CPU Skew | CPUSKEW | Averaging on | | 35 | 100 | ps | |
| SRC Skew | t _{SKEW} SRC | Averaging on, SRC to SATA skew when Byte0, bit 1 = 0 | | 259 | 350 | ps | |

NOTES: (unless otherwise noted, guaranteed by design and characterization, not 100% tested in production). C_L = 2pF, R_s = 0 ohms.

¹Measurement taken for single ended waveform on a component test board (not in system)

²Measurement taken from differential waveform on a component test board. (not in system)

³Slew rate emasured through V_{swing} voltage range centered about differential zero

⁴V_{cross} is defined at the voltage where Clock = Clock#, measured on a component test board (not in system)

⁵Only applies to the differential rising edge (Clock rising, Clock# falling)

⁶Matching applies to rising edge rate for Clock and falling edge rate for Clock#. It is measured using a +/-75mV window centered on the average cross point where Clock rising meets Clock# falling. The median cross point is used to calculate the voltage

⁷The max voltage including overshoot.

⁸The min voltage including undershoot.

⁹The total variation of all V_{cross} measurements in any particular system. Note this is a subset of V_{cross} min/mas (V_{Cross} absolute) allowed. The intent is to limit V_{cross} induced modulation by setting C_{cross_delta} to be smaller than V_{Cross} absolute

Clock Jitter Specs - Low Power Differential Outputs, Commercial Temperature Range

| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | UNITS | Notes |
|----------------------------------|--------------------------|--|-----|-----|-----|----------|-------|
| CPU Jitter - Cycle to Cycle | CPUJC2C | Differential Measurement | | 50 | 85 | ps | 1 |
| SRC/SATA Jitter - Cycle to Cycle | SRCJC2C | Differential Measurement | | 50 | 125 | ps | 1,2 |
| DOT Jitter - Cycle to Cycle | DOTJC2C | Differential Measurement | | 50 | 250 | ps | 1 |
| SRC Phase Jitter | t _{jphase} PLL | PCIe Gen 1 | | 35 | 86 | ps (p-p) | 1,2,3 |
| | t _{jphase} Lo | PCIe Gen 2 10kHz < f < 1.5MHz | | 1.8 | 3 | ps (RMS) | 1,2,3 |
| | t _{jphase} High | PCIe Gen 2 1.5MHz < f < Nyquist (50MHz) | | 2.3 | 3.1 | ps (RMS) | 1,2,3 |

NOTES: (unless otherwise noted, guaranteed by design and characterization, not 100% tested in production). C_L = 2pF, R_s = 0 ohms.

¹Jitter specs are specified as measured on a clock characterization board. System designers need to take special care not to use these numbers, as the in-system performance will be somewhat degraded. The receiver EMTS (chispet or CPU) will have the receiver jitter specs as measured in a real system.

²Phase jitter requirement: The designated Gen2 outputs will meet the reference clock jitter requirements from the PCI Express Gen2 Base Spec. The test is performed on a component test board under quiet conditions with all outputs on.

³See <http://www.pcisig.com> for complete specs

Electrical Characteristics - REF-14.318MHz, Commercial Temperature Range

| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | UNITS | Notes |
|-------------------------------|----------------------|--|----------|----------|----------|-------|-------|
| Long Accuracy | ppm | see Tperiod min-max values | -100 | 0 | 100 | ppm | 2, 4 |
| Clock period | Tperiod | 14.318MHz output nominal | 69.82033 | 69.84129 | 69.86224 | ns | 2, 3 |
| Absolute min/max period | Tab | 14.318MHz output nominal | 69.83400 | | 70.84800 | ns | 2 |
| CLK High Time | THIGH | | 29.97543 | | 38.46654 | V | |
| CLK Low time | TLOW | | 29.57543 | | 38.26654 | V | |
| Output High Current | IOH | VOH @MIN = 1.0 V, VOH@MAX = 3.135 V | -33 | | -33 | mA | |
| Output Low Current | IOL | VOL @MIN = 1.95 V, VOL @MAX = 0.4 V | 30 | | 38 | mA | |
| Rising/Falling Edge Slew Rate | t _{SLEW} | Measured between 0.8 to 2.0 V | 1 | 1.7 | 4 | V/ns | 1 |
| Duty Cycle | dt1 | V _T = 1.5 V | 45 | 53 | 55 | % | 2 |
| Jitter, Cycle to cycle | t _{jyc-cyc} | V _T = 1.5 V | | 115 | 1000 | ps | 2 |

NOTES: (unless otherwise noted, guaranteed by design and characterization, not 100% tested in production).

¹Edge rate in system is measured from 0.8V to 2.0V.

²Duty cycle, Period and Jitter are measured with respect to 1.5V

³The average period over any 1us period of time

⁴Using frequency counter with the measurement interval equal or greater that 0.15s, target frequency is 14.318180 MHz

Electrical Characteristics - 27MHz_Spread / 27MHz_NonSpread, Commercial Temperature Range

| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | UNITS | Notes |
|--------------------------------|----------------------|---|---------|------|---------|-------|-------|
| Long Accuracy | ppm | see Tperiod min-max values | -50 | | 50 | ppm | 1,2 |
| | | | -15 | | 15 | | 1,2,3 |
| Clock period | T _{period} | 27.000MHz output nominal | 37.0365 | | 37.0376 | | |
| Output High Current | I _{OH} | VOH @MIN = 1.0 V, VOH@MAX = 3.135 V | -29 | | -23 | mA | 1 |
| Output Low Current | I _{OL} | VOL @MIN = 1.95 V, VOL @MAX = 0.4 V | 29 | | 27 | mA | 1 |
| Rising/Falling Edge Slew Rate | t _{slewr/f} | Rising/Falling edge rate | 1 | 2 | 4 | V/ns | 1 |
| Duty Cycle | d _{t1} | V _T = 1.5 V | 45 | 50.4 | 55 | % | 1 |
| Jitter, 27MHz_NonSpread Output | t _{jt} | Long Term (10us) | | 485 | 800 | ps | |
| | | V _T = 1.5 V | -100 | | 100 | ps | |
| | | V _T = 1.5 V | | 57 | 120 | ps | |
| Jitter, 27MHz_Spread Output | t _{jyc-cyc} | V _T = 1.5 V SS% <= 1.5% pk to pk | | 82 | 200 | ps | 4 |
| | | V _T = 1.5 V, SS% > 1.5% pk to pk | | 134 | 200 | ps | 4 |

NOTES: (unless otherwise noted, guaranteed by design and characterization, not 100% tested in production).

¹Edge rate in system is measured from 0.8V to 2.0V at default slew rate control setting.

²All Long Term Accuracy and Clock Period specifications are guaranteed assuming that REF out is at 14.31818MHz

³At nominal temperature and voltage.

⁴Long term and peak to peak jitter do not apply to the 27MHz spreading output. The spread modulation directly impacts these values.

Absolute Maximum Ratings - DC Parameters, Industrial Temperature Range

| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | UNITS | Notes |
|------------------------|-----------------------|-------------------------------------|-----------|-----|-----|-------|-------|
| Maximum Supply Voltage | VDD _{xxx} | Supply Voltage | | | 4.6 | V | 1 |
| Maximum Supply Voltage | VDD _{xxx IO} | Low-Voltage Differential I/O Supply | | | 3.8 | V | 1 |
| Maximum Input Voltage | V _{IH} | 3.3V Tolerant Inputs | | | 4.6 | V | 1,2 |
| Minimum Input Voltage | V _{IL} | Any Input | GND - 0.5 | | | V | 1 |
| Storage Temperature | T _s | - | -65 | | 150 | °C | 1 |
| Input ESD protection | ESD prot | Human Body Model | 2000 | | | V | 1,3 |

Notes: (unless otherwise noted, guaranteed by design and characterization, not 100% tested in production).

¹ Operation under these conditions is neither implied, nor guaranteed.

² Maximum V_{IH} is not to exceed VDD

³ Human Body Model

Electrical Characteristics - Input/Supply/Common Output DC Parameters, Industrial Temperature Range

| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | UNITS | Notes |
|---|------------------------|---|-----------------------|--------|-----------------------|-------|-------|
| Ambient Operating Temp | T _{ambind} | Industrial Range | -40 | | 85 | °C | |
| Supply Voltage, Core | VDD _{xxx} | Supply Voltage | 3.135 | 3.3 | 3.465 | V | |
| Supply Voltage, I/O | VDD _{xxx IO} | Low-Voltage Differential I/O Supply | 0.9975 | 1.05 | 3.465 | V | 5 |
| Input High Voltage | V _{IHSE} | Single-ended 3.3V inputs | 2 | 2.4 | V _{DD} + 0.3 | V | 3 |
| Input Low Voltage | V _{ILSE} | Single-ended 3.3V inputs | V _{SS} - 0.3 | 0.4 | 0.8 | V | 3 |
| Low Threshold Input - High Voltage | V _{IH_FSC} | 3.3 V +/-5%, Voltage for which FSC = '1' | 0.7 | | 3.3 | V | 4 |
| Low Threshold Input - Low Voltage | V _{IL_FSC} | 3.3 V +/-5% | V _{SS} - 0.3 | | 0.35 | V | |
| Input Leakage Current | I _{IN} | V _{IN} = V _{DD} , V _{IN} = GND | -5 | | 5 | uA | 2 |
| Input Leakage Current | I _{INRES} | Inputs with pull up or pull down resistors V _{IN} = V _{DD} , V _{IN} = GND | -200 | | 200 | uA | |
| Output High Voltage | V _{OHSE} | Single-ended outputs, I _{OH} = -1mA | 2.4 | | | V | 1 |
| Output Low Voltage | V _{OLSE} | Single-ended outputs, I _{OL} = 1 mA | | | 0.4 | V | 1 |
| Operating Supply Current | I _{DDOP3.3} | Full Active, C _L = Full load; I _{DD} 3.3V | | 92 | 110 | mA | |
| | I _{DDOPIO} | Full Active, C _L = Full load; I _{DD} IO | | 18 | 25 | mA | 5 |
| iAMT Mode Current | I _{DDIAMT3.3} | M1 mode, 3.3V Rail | | 48 | 65 | mA | |
| | I _{DDIAMTIO} | M1 Mode, IO Rail | | 6 | 15 | mA | 5 |
| Powerdown Current | I _{DDPD3.3} | Power down mode, 3.3V Rail | | 3.2 | 8 | mA | |
| | I _{DDPDIO} | Power down mode, IO Rail | | 0 | 0.05 | mA | 5 |
| Input Frequency | F _i | V _{DD} = 3.3 V | | 14.318 | 15 | MHz | |
| Pin Inductance | L _{pin} | | | 5 | 7 | nH | |
| Input Capacitance | C _{IN} | Logic Inputs | 1.5 | 4 | 5 | pF | |
| | C _{OUT} | Output pin capacitance | | 5 | 6 | pF | |
| | C _{INX} | X1 & X2 pins | | 4 | 6 | pF | |
| Clk Stabilization | T _{STAB} | From VDD Power-Up or de-assertion of PD to 1st clock | | | 1.8 | ms | |
| T _{fall_SE} | T _{FALL} | Fall/rise time of all 3.3V control inputs from 20-80% | | | 10 | ns | 1 |
| T _{rise_SE} | T _{RISE} | | | | 10 | ns | 1 |
| SMBus Voltage | V _{DD} | | 2.7 | 3.3 | 5.5 | V | |
| Low-level Output Voltage | V _{OLSMB} | @ I _{PULLUP} | | | 0.4 | V | |
| Current sinking at V _{OLSMB} = 0.4 V | I _{PULLUP} | SMB Data Pin | 4 | 5 | | mA | |
| SCLK/SDATA Clock/Data Rise Time | T _{RI2C} | (Max V _{IL} - 0.15) to (Min V _{IH} + 0.15) | | | 1000 | ns | |
| SCLK/SDATA Clock/Data Fall Time | T _{FI2C} | (Min V _{IH} + 0.15) to (Max V _{IL} - 0.15) | | | 300 | ns | |
| Maximum SMBus Operating Frequency | F _{SMBUS} | | | | 100 | kHz | |
| Spread Spectrum Modulation Frequency | f _{SSMOD} | Triangular Modulation | 30 | 32.54 | 33 | kHz | |

Notes: (unless otherwise noted, guaranteed by design and characterization, not 100% tested in production).

¹ Signal is required to be monotonic in this region.

² Input leakage current does not include inputs with pull-up or pull-down resistors

³ 3.3V referenced inputs are: SCLK, SDATA, and CKPWRGD

⁴ Frequency Select pins which have tri-level input

⁵ If present, not all parts have this feature.

AC Electrical Characteristics - Low Power Differential Outputs, Industrial Temperature Range

| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | UNITS | NOTES |
|----------------------------|---------------|--|------|------|------|-------|-------|
| Rising Edge Slew Rate | t_{SLR} | Averaging on | 2.5 | 3.7 | 4.2 | V/ns | 2, 3 |
| Falling Edge Slew Rate | t_{FLR} | Averaging on | 2.5 | 3.7 | 4.2 | V/ns | 2, 3 |
| Slew Rate Variation | t_{SLVAR} | Averaging on | | 12.2 | 20 | % | 1, 6 |
| Differential Voltage Swing | V_{SWING} | Averaging off | 300 | | | mV | 2 |
| Crossing Point Voltage | V_{XABS} | Averaging off | 300 | 447 | 550 | mV | 1,4,5 |
| Crossing Point Variation | $V_{XABSVAR}$ | Averaging off | | 19 | 140 | mV | 1,4,9 |
| Maximum Output Voltage | V_{HIGH} | Averaging off | | 941 | 1150 | mV | 1,7 |
| Minimum Output Voltage | V_{LOW} | Averaging off | -300 | -43 | | mV | 1,8 |
| Duty Cycle | DCYC | Averaging on | 45 | 49.8 | 55 | % | 2 |
| CPU Skew | $t_{SKEWCPU}$ | Averaging on | | 35 | 100 | ps | |
| SRC Skew | $t_{SKEWSRC}$ | Averaging on, SRC to SATA skew when Byte0, bit 1 = 0 | | 288 | 350 | ps | |

NOTES: (unless otherwise noted, guaranteed by design and characterization, not 100% tested in production). $C_L = 2pF$, $R_s = 0$ ohms.

¹Measurement taken for single ended waveform on a component test board (not in system)

²Measurement taken from differential waveform on a component test board. (not in system)

³Slew rate measured through minimum V_{swing} voltage range centered about differential zero

⁴ V_{cross} is defined at the voltage where Clock = Clock#, measured on a component test board (not in system)

⁵Only applies to the differential rising edge (Clock rising, Clock# falling)

⁶Matching applies to rising edge rate for Clock and falling edge rate for Clock#. It is measured using a +/-75mV window centered on the average cross point where Clock rising meets Clock# falling. The median cross point is used to calculate the voltage

⁷The max voltage including overshoot.

⁸The min voltage including undershoot.

⁹The total variation of all V_{cross} measurements in any particular system. Note this is a subset of V_{cross} min/max (V_{Cross} absolute) allowed. The intent is to limit V_{cross} induced modulation by setting C_{cross_delta} to be smaller than V_{Cross} absolute

Clock Jitter Specifications - Low Power Differential Outputs, Industrial Temperature Range

| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | UNITS | NOTES |
|------------------------------|------------------|--|-----|-----|-----|----------|-------|
| CPU Jitter - Cycle to Cycle | $CPUJ_{C2C}$ | Differential Measurement | | 55 | 85 | ps | 1 |
| SRC Jitter - Cycle to Cycle | $SRCJ_{C2C}$ | Differential Measurement | | 55 | 125 | ps | 1 |
| SATA Jitter - Cycle to Cycle | $SATAJ_{C2C}$ | Differential Measurement | | 55 | 125 | ps | 1 |
| DOT Jitter - Cycle to Cycle | $DOTJ_{C2C}$ | Differential Measurement | | 55 | 250 | ps | 1 |
| SRC Phase Jitter | $t_{jphasePLL}$ | PCIe Gen 1 | | 45 | 86 | ps (p-p) | 1,2,3 |
| | $t_{jphaseLo}$ | PCIe Gen 2 10kHz < f < 1.5MHz | | 2 | 3 | ps (RMS) | 1,2,3 |
| | $t_{jphaseHigh}$ | PCIe Gen 2 1.5MHz < f < Nyquist (50MHz) | | 2.6 | 3.1 | ps (RMS) | 1,2,3 |

NOTES: (unless otherwise noted, guaranteed by design and characterization, not 100% tested in production). $C_L = 2pF$, $R_s = 0$ ohms.

¹Jitter specs are specified as measured on a clock characterization board. System designers need to take special care not to use these numbers, as the in-system performance will be somewhat degraded. The receiver EMTS (chispet or CPU) will have the receiver jitter specs as measured in a real system.

²Phase jitter requirement: The designated Gen2 outputs will meet the reference clock jitter requirements from the PCI Express Gen2 Base Spec. The test is performed on a component test board under quiet conditions with all outputs on.

³See <http://www.pcisig.com> for complete specs

Electrical Characteristics - REF-14.318MHz, Industrial Temperature Range

| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | UNITS | Notes |
|-------------------------------|----------|--|----------|----------|----------|-------|-------|
| Long Accuracy | ppm | see Tperiod min-max values | -100 | 0 | 100 | ppm | 2, 4 |
| Clock period | Tperiod | 14.318MHz output nominal | 69.82033 | 69.84129 | 69.86224 | ns | 2, 3 |
| Absolute min/max period | Tabs | 14.318MHz output nominal | 69.83400 | | 70.84800 | ns | 2 |
| CLK High Time | THIGH | | 29.97543 | | 38.46654 | V | |
| CLK Low time | TLOW | | 29.57543 | | 38.26654 | V | |
| Output High Current | IOH | VOH @MIN = 1.0 V, VOH@MAX = 3.135 V | -33 | | -33 | mA | |
| Output Low Current | IOL | VOL @MIN = 1.95 V, VOL @MAX = 0.4 V | 30 | | 38 | mA | |
| Rising/Falling Edge Slew Rate | tSLEW | Measured between 0.8 to 2.0 V | 1 | 1.8 | 4 | V/ns | 1 |
| Duty Cycle | dt1 | VT = 1.5 V | 45 | 52.8 | 55 | % | 2 |
| Jitter, Cycle to cycle | tjyc-cyc | VT = 1.5 V | | 122 | 500 | ps | 2 |

NOTES: (unless otherwise noted, guaranteed by design and characterization, not 100% tested in production).

¹Edge rate in system is measured from 0.8V to 2.0V at default slew rate control setting.

²Duty cycle, Period and Jitter are measured with respect to 1.5V

³The average period over any 1us period of time

⁴Using frequency counter with the measurement interval equal or greater that 0.15s, target frequency is 14.318180 MHz

Electrical Characteristics - 27MHz_Spread / 27MHz_NonSpread, Industrial Temperature Range

| PARAMETER | SYMBOL | CONDITIONS | MIN | TYP | MAX | UNITS | Notes |
|--------------------------------|----------|--|---------|------|---------|-------|-------|
| Long Accuracy | ppm | see Tperiod min-max values | -50 | | 50 | ppm | 1,2 |
| | | | -15 | | 15 | | 1,2,3 |
| Clock period | Tperiod | 27.000M outputs, 27M SS with SS OFF | 37.0365 | | 37.0376 | | |
| Output High Current | IOH | VOH @MIN = 1.0 V, VOH@MAX = 3.135 V | -29 | | -23 | mA | |
| Output Low Current | IOL | VOL @MIN = 1.95 V, VOL @MAX = 0.4 V | 29 | | 27 | mA | |
| Rising/Falling Edge Slew Rate | tSLEW | Measured between 0.8 to 2.0 V | 1 | 2 | 4 | V/ns | 1 |
| Duty Cycle | dt1 | VT = 1.5 V | 45 | 50.4 | 55 | % | |
| Jitter, 27MHz_NonSpread Output | tRj | Long Term (10us) | | 485 | 800 | ps | |
| | tjpk-pk | VT = 1.5 V | -100 | | 100 | ps | |
| | tjvc-cvc | VT = 1.5 V | | 57 | 120 | ps | |
| Jitter, 27MHz_Spread Output | tjyc-cyc | VT = 1.5 V SS% <= 1.5% pk to pk | | 108 | 200 | ps | 4 |
| | | VT = 1.5 V, SS% > 1.5% pk to pk | | 140 | 200 | ps | 4 |

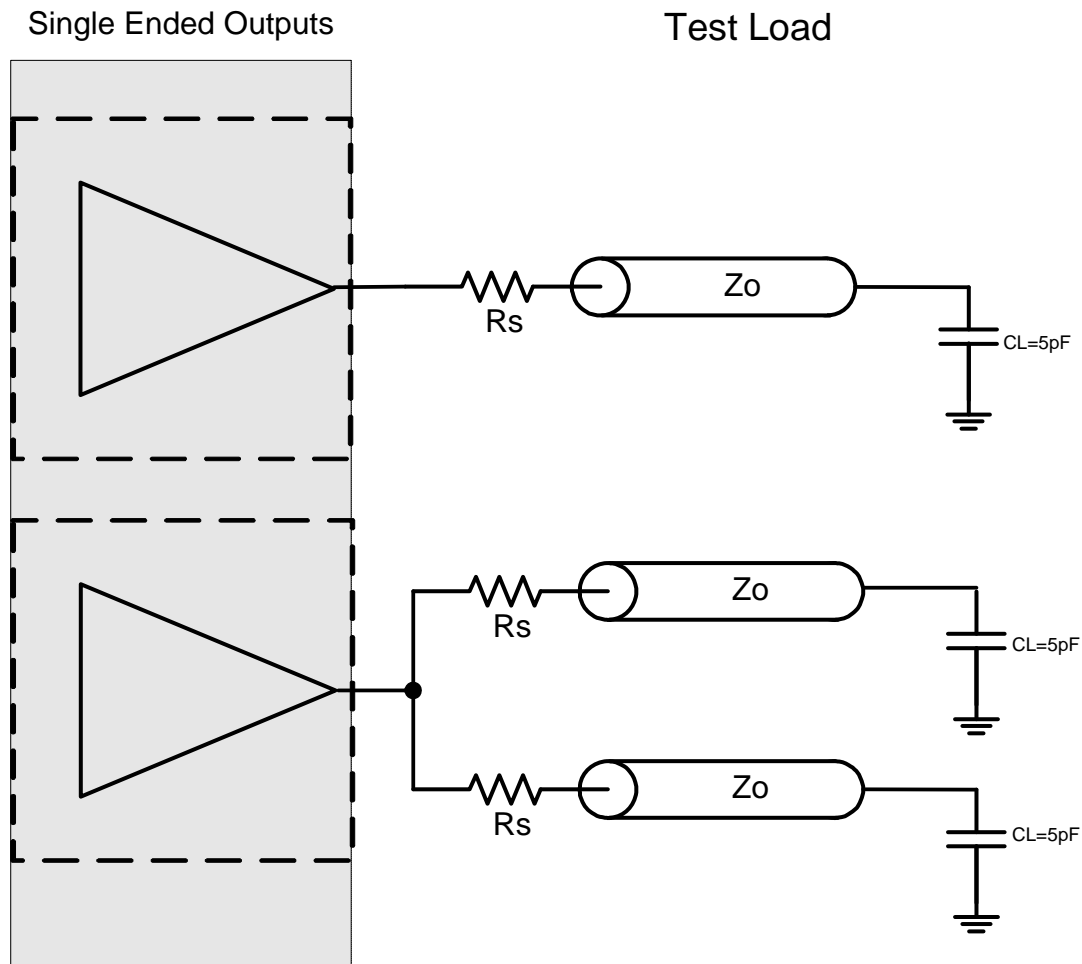
NOTES: (unless otherwise noted, guaranteed by design and characterization, not 100% tested in production).

¹Edge rate in system is measured from 0.8V to 2.0V at default slew rate control setting.

²All Long Term Accuracy and Clock Period specifications are guaranteed assuming that REF out is at 14.31818MHz

³At nominal temperature and voltage.

⁴Long term and peak to peak jitter do not apply to the 27MHz spreading output. The spread modulation directly impacts these values.



Suggested Suggested termination resistors for various driving conditions are as follows for transmission lines with $Z_o = 50$ ohms:

| | |
|---------------------------|----------------------------------|
| REF Output | Driving 1 load, $R_s = 39$ ohms |
| | Driving 2 loads, $R_s = 22$ ohms |
| 27M SS and Non-SS outputs | Driving 1 load, $R_s = 39$ ohms |
| | Driving 2 loads, $R_s = 22$ ohms |

Clock Periods Differential Outputs with Spread Spectrum Enabled

| Measurement Window | | 1 Clock | 1us | 0.1s | 0.1s | 0.1s | 1us | 1 Clock | | |
|--------------------|---------|-----------------|--------------------|-------------------|----------|-------------------|--------------------|-----------------|-------|-------|
| Symbol | | - c-c jitter | -SSC | -ppm error | 0ppm | + ppm error | +SSC | + c-c jitter | | |
| Definition | | Absolute Period | Short-term Average | Long-Term Average | Period | Long-Term Average | Short-term Average | Absolute Period | Units | Notes |
| | | Minimum | Minimum | Minimum | Nominal | Maximum | Maximum | Maximum | | |
| Signal Name | SRC 100 | 9.87400 | 9.99900 | 9.99900 | 10.00000 | 10.00100 | 10.05130 | 10.17630 | ns | 1,2 |
| | CPU 100 | 9.91400 | 9.99900 | 9.99900 | 10.00000 | 10.00100 | 10.05130 | 10.13630 | ns | 1,2 |
| | CPU 133 | 7.41425 | 7.49925 | 7.49925 | 7.50000 | 7.50075 | 7.53845 | 7.62345 | ns | 1,2 |
| | CPU 166 | 5.91440 | 5.99940 | 5.99940 | 6.00000 | 6.00060 | 6.03076 | 6.11576 | ns | 1,2 |
| | CPU 200 | 4.91450 | 4.99950 | 4.99950 | 5.00000 | 5.00050 | 5.02563 | 5.11063 | ns | 1,2 |
| | CPU 266 | 3.66463 | 3.74963 | 3.74963 | 3.75000 | 3.75038 | 3.76922 | 3.85422 | ns | 1,2 |
| | CPU 333 | 2.91470 | 2.99970 | 2.99970 | 3.00000 | 3.00030 | 3.01538 | 3.10038 | ns | 1,2 |
| | CPU 400 | 2.41475 | 2.49975 | 2.49975 | 2.50000 | 2.50025 | 2.51282 | 2.59782 | ns | 1,2 |

Clock Periods Differential Outputs with Spread Spectrum Disabled

| Measurement Window | | 1 Clock | 1us | 0.1s | 0.1s | 0.1s | 1us | 1 Clock | | |
|--------------------|---------|-----------------|--------------------|-------------------|----------|-------------------|--------------------|-----------------|-------|-------|
| Symbol | | - c-c jitter | -SSC | -ppm error | 0ppm | + ppm error | +SSC | + c-c jitter | | |
| Definition | | Absolute Period | Short-term Average | Long-Term Average | Period | Long-Term Average | Short-term Average | Absolute Period | Units | Notes |
| | | Minimum | Minimum | Minimum | Nominal | Maximum | Maximum | Maximum | | |
| Signal Name | SRC 100 | 9.87400 | | 9.99900 | 10.00000 | 10.00100 | | 10.17630 | ns | 1,2 |
| | CPU 100 | 9.91400 | | 9.99900 | 10.00000 | 10.00100 | | 10.13630 | ns | 1,2 |
| | CPU 133 | 7.41425 | | 7.49925 | 7.50000 | 7.50075 | | 7.62345 | ns | 1,2 |
| | CPU 166 | 5.91440 | | 5.99940 | 6.00000 | 6.00060 | | 6.11576 | ns | 1,2 |
| | CPU 200 | 4.91450 | | 4.99950 | 5.00000 | 5.00050 | | 5.11063 | ns | 1,2 |
| | CPU 266 | 3.66463 | | 3.74963 | 3.75000 | 3.75038 | | 3.85422 | ns | 1,2 |
| | CPU 333 | 2.91470 | | 2.99970 | 3.00000 | 3.00030 | | 3.10038 | ns | 1,2 |
| | CPU 400 | 2.41475 | | 2.49975 | 2.50000 | 2.50025 | | 2.59782 | ns | 1,2 |
| | DOT 96 | 10.16560 | | 10.41560 | 10.41670 | 10.41770 | | 10.66770 | ns | 1,2 |

Notes:

¹ Guaranteed by design and characterization, not 100% tested in production.

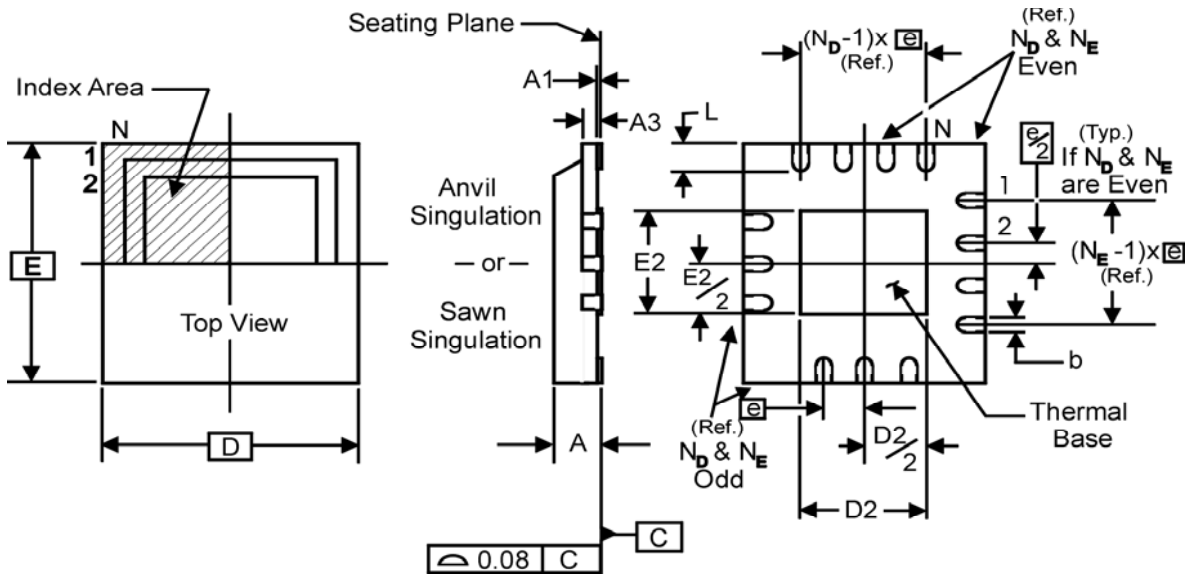
² All Long Term Accuracy and Clock Period specifications are guaranteed assuming that REFOUT is at 14.31818MHz

Test Clarification Table

| Comments | HW | | SW | | OUTPUT |
|--|-----------------------------|------------------------------|---------------------------|--------------------------|--------|
| | FSLC/ TEST_SEL HW PIN | FSLB/ TEST_MODE HW PIN | TEST ENTRY BIT B9b3 | REF/N or HI-Z B9b4 | |
| | <2.0V | X | 0 | 0 | NORMAL |
| Power-up w/ TEST_SEL = 1 to enter test mode | >2.0V | 0 | X | 0 | HI-Z |
| Cycle power to disable test mode | >2.0V | 0 | X | 1 | REF/N |
| FSLC./TEST_SEL -->3-level latched input | >2.0V | 1 | X | 0 | REF/N |
| If power-up w/ V>2.0V then use TEST_SEL | | | | | |
| If power-up w/ V<2.0V then use FSLC | >2.0V | 1 | X | 1 | REF/N |
| FSLB/TEST_MODE -->low Vth input | | | | | |
| TEST_MODE is a real time input | | | | | |
| | <2.0V | X | 1 | 0 | HI-Z |
| If TEST_SEL HW pin is 0 during power-up, test mode can be invoked through B9b3. | | | | | |
| If test mode is invoked by B9b3, only B9b4 is used to select HI-Z or REF/N | <2.0V | X | 1 | 1 | REF/N |
| FSLB/TEST_Mode pin is not used. | | | | | |
| Cycle power to disable test mode, one shot control | | | | | |

B9b3: 1= ENTER TEST MODE, Default = 0 (NORMAL OPERATION)

B9b4: 1= REF/N, Default = 0 (HI-Z)



THERMALLY ENHANCED, VERY THIN, FINE PITCH
QUAD FLAT / NO LEAD PLASTIC PACKAGE

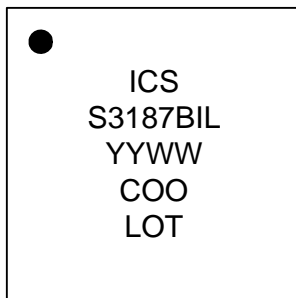
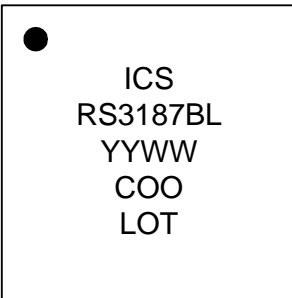
DIMENSIONS

| SYMBOL | MIN. | MAX. |
|--------|----------------|------|
| A | 0.8 | 1.0 |
| A1 | 0 | 0.05 |
| A3 | 0.20 Reference | |
| b | 0.18 | 0.3 |
| e | 0.50 BASIC | |

DIMENSIONS

| SYMBOL | ICS 32L TOLERANCE |
|----------------|-------------------|
| N | 32 |
| N_D | 8 |
| N_E | 8 |
| D x E BASIC | 5.00 x 5.00 |
| D2 MIN. / MAX. | 3.0 / 3.3 |
| E2 MIN. / MAX. | 3.0 / 3.3 |
| L MIN. / MAX. | 0.30 / 0.50 |

Marking Diagrams



Ordering Information

| Part / Order Number | Shipping Package | Package | Temperature |
|---------------------|------------------|------------|---------------|
| 9LRS3187BKLF | Tubes | 32-pin MLF | 0 to +70° C |
| 9LRS3187BKLFT | Tape and Reel | 32-pin MLF | 0 to +70° C |
| 9LRS3187BKILF | Tubes | 32-pin MLF | -40 to +85° C |
| 9LRS3187BKILFT | Tape and Reel | 32-pin MLF | -40 to +85° C |

“LF” suffix to the part number are the Pb-Free configuration and are RoHS compliant.

“B” is the device revision designator (will not correlate to the datasheet revision).

Revision History

| | | | | |
|---|----------|-----|---|----|
| A | 04/13/10 | RDW | Released to final | |
| B | 04/15/10 | RDW | Revised Commercial and Industrial Electrical Tables for Consistency | |
| C | 06/02/10 | LPL | Added Features bullet: Meets PCIe Gen2 Specifications | 1 |
| D | 10/01/10 | LPL | Updated pins 1/2 descriptions | 2 |
| E | 04/29/11 | RDW | Updated marking diagrams | 19 |
| F | 11/04/11 | DC | Updated CPU/SRC specs under Key Specifications | 1 |

Innovate with IDT and accelerate your future networks. Contact:

www.IDT.com

For Sales

800-345-7015
408-284-8200
Fax: 408-284-2775

For Tech Support

408-284-6578
pcclockhelp@idt.com

Corporate Headquarters

Integrated Device Technology, Inc.
6024 Silver Creek Valley Road
San Jose, CA 95138
United States
800 345 7015
+408 284 8200 (outside U.S.)

Asia Pacific and Japan

IDT Singapore Pte. Ltd.
1 Kallang Sector #07-01/06
KolamAyer Industrial Park
Singapore 349276
Phone: 65-6-744-3356
Fax: 65-6-744-1764

Europe

IDT Europe Limited
321 Kingston Road
Leatherhead, Surrey
KT22 7TU
England
Phone: 44-1372-363339
Fax: 44-1372-378851



© 2010 Integrated Device Technology, Inc. All rights reserved. Product specifications subject to change without notice. IDT, ICS, and the IDT logo are trademarks of Integrated Device Technology, Inc. Accelerated Thinking is a service mark of Integrated Device Technology, Inc. All other brands, product names and marks are or may be trademarks or registered trademarks used to identify products or services of their respective owners.
Printed in USA

Компания «Life Electronics» занимается поставками электронных компонентов импортного и отечественного производства от производителей и со складов крупных дистрибьюторов Европы, Америки и Азии.

С конца 2013 года компания активно расширяет линейку поставок компонентов по направлению коаксиальный кабель, кварцевые генераторы и конденсаторы (керамические, пленочные, электролитические), за счёт заключения дистрибьюторских договоров

Мы предлагаем:

- Конкурентоспособные цены и скидки постоянным клиентам.
- Специальные условия для постоянных клиентов.
- Подбор аналогов.
- Поставку компонентов в любых объемах, удовлетворяющих вашим потребностям.
- Приемлемые сроки поставки, возможна ускоренная поставка.
- Доставку товара в любую точку России и стран СНГ.
- Комплексную поставку.
- Работу по проектам и поставку образцов.
- Формирование склада под заказчика.
- Сертификаты соответствия на поставляемую продукцию (по желанию клиента).
- Тестирование поставляемой продукции.
- Поставку компонентов, требующих военную и космическую приемку.
- Входной контроль качества.
- Наличие сертификата ISO.

В составе нашей компании организован Конструкторский отдел, призванный помогать разработчикам, и инженерам.

Конструкторский отдел помогает осуществить:

- Регистрацию проекта у производителя компонентов.
- Техническую поддержку проекта.
- Защиту от снятия компонента с производства.
- Оценку стоимости проекта по компонентам.
- Изготовление тестовой платы монтаж и пусконаладочные работы.



Тел: +7 (812) 336 43 04 (многоканальный)
Email: org@lifeelectronics.ru